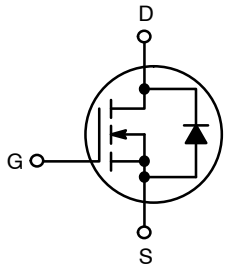
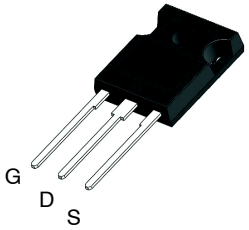
Silicon Carbide (SiC) MOSFET – EliteSiC, 20 mohm, 900 V, M2, TO-247-3L

NTHL020N090SC1

$V_{(BR)DSS}$	$R_{DS(ON)}$ MAX	I_D MAX
900 V	28 mΩ @ 15 V	118 A



N−CHANNEL MOSFET



TO−247−3LD
CASE 340CX

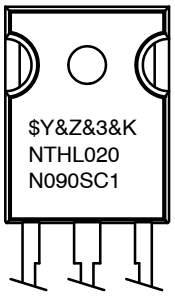
Features

- Typ. $R_{DS(on)}$ = 20 mΩ @ V_{GS} = 15 V
- Typ. $R_{DS(on)}$ = 16 mΩ @ V_{GS} = 18 V
- Ultra Low Gate Charge ($Q_{G(tot)}$ = 196 nC)
- Low Effective Output Capacitance (C_{oss} = 296 pF)
- 100% UIL Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb−Free 2LI (on second level interconnection)

Typical Applications

- UPS
- DC−DC Converter
- Boost Inverter

MARKING DIAGRAM



$Y = **onsemi** Logo
&Z = Assembly Plant Code
&3 = Date Code (Year & Week)
&K = Lot
NTHL020N090SC1 = Specific Device Code

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain−to−Source Voltage			V_{DSS}	900	V
Gate−to−Source Voltage			V_{GS}	+22/−8	V
Recommended Operation Values of Gate − Source Voltage		T_C < 175°C	V_{GSop}	+15/−5	V
Continuous Drain Current $R_{\theta JC}$	Steady State	T_C = 25°C	I_{DC}	118	A
Power Dissipation $R_{\theta JC}$	Steady State	T_C = 25°C	P_{DC}	503	W
Continuous Drain Current $R_{\theta JC}$	Steady State	T_C = 100°C	I_{DC}	83	A
Power Dissipation $R_{\theta JC}$	Steady State	T_C = 100°C	P_{DC}	251	W
Pulsed Drain Current (Note 2)		T_A = 25°C	I_{DM}	472	A
Operating Junction and Storage Temperature Range			T_J, T_{stg}	−55 to +175	°C
Source Current (Body Diode)			I_S	153	A
Single Pulse Drain−to−Source Avalanche Energy (I_L = 23 A_{pk}, L = 1 mH) (Note 3)			E_{AS}	264	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. Repetitive rating, limited by max junction temperature.
3. E_{AS} of 162 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 23 A, V_{DD} = 100 V, V_{GS} = 15 V.

ORDERING INFORMATION

Device	Package	Shipping
NTHL020N090SC1	TO−247−3LD	30 Units / Tube

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Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Thermal Resistance Junction−to−Case (Note 1)	$R_{\theta JC}$	0.30	°C/W
Thermal Resistance Junction−to−Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
OFF CHARACTERISTICS							
Drain−to−Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 1 mA		900			V
Drain−to−Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$	I_D = 1 mA, refer to 25°C			500		mV/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 900 V	T_J = 25°C			100	μA
			T_J = 175°C			250	μA
Gate−to−Source Leakage Current	I_{GSS}	V_{GS} = +22/−8 V, V_{DS} = 0 V				±1	μA
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} = V_{DS} , I_D = 20 mA		1.8	2.7	4.3	V
Recommended Gate Voltage	V_{GOP}			−5		+15	V
Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 15 V, I_D = 60 A, T_J = 25°C			20	28	mΩ
		V_{GS} = 18 V, I_D = 60 A, T_J = 25°C			16		
		V_{GS} = 15 V, I_D = 60 A, T_J = 175°C			27		
Forward Transconductance	g_{FS}	V_{DS} = 20 V, I_D = 60 A			49		S
CHARGES, CAPACITANCES & GATE RESISTANCE							
Input Capacitance	C_{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 450 V			4415		pF
Output Capacitance	C_{OSS}				296		
Reverse Transfer Capacitance	C_{RSS}				24		
Total Gate Charge	$Q_{G(TOT)}$	V_{GS} = −5/15 V, V_{DS} = 720 V, I_D = 60 A			196		nC
Threshold Gate Charge	$Q_{G(TH)}$				42		
Gate−to−Source Charge	Q_{GS}				78		
Gate−to−Drain Charge	Q_{GD}				55		
Gate−Resistance	R_G	f = 1 MHz			1.6		Ω
SWITCHING CHARACTERISTICS							
Turn−On Delay Time	$t_{d(ON)}$	V_{GS} = −5/15 V, V_{DS} = 720 V, I_D = 60 A, R_G = 2.5 Ω, Inductive Load			40		ns
Rise Time	t_r				63		
Turn−Off Delay Time	$t_{d(OFF)}$				55		
Fall Time	t_f				13		
Turn−On Switching Loss	E_{ON}				2025		μJ
Turn−Off Switching Loss	E_{OFF}				201		
Total Switching Loss	E_{TOT}				2226		
DRAIN−SOURCE DIODE CHARACTERISTICS							
Continuous Drain−Source Diode Forward Current	I_{SD}	V_{GS} = −5 V, T_J = 25°C				153	A
Pulsed Drain−Source Diode Forward Current (Note 2)	I_{SDM}	V_{GS} = −5 V, T_J = 25°C				472	A
Forward Diode Voltage	V_{SD}	V_{GS} = −5 V, I_{SD} = 30 A, T_J = 25°C			3.8		V

Table 2. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
DRAIN−SOURCE DIODE CHARACTERISTICS						
Reverse Recovery Time	t_{RR}	V_{GS} = −5/15 V, I_{SD} = 60 A, dI_S/dt = 1000 A/μs, V_{DS} = 720 V		28		ns
Reverse Recovery Charge	Q_{RR}			199		nC
Reverse Recovery Energy	E_{REC}			4		μJ
Peak Reverse Recovery Current	I_{RRM}			14		A
Charge Time	Ta			16		ns
Discharge Time	Tb			12		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

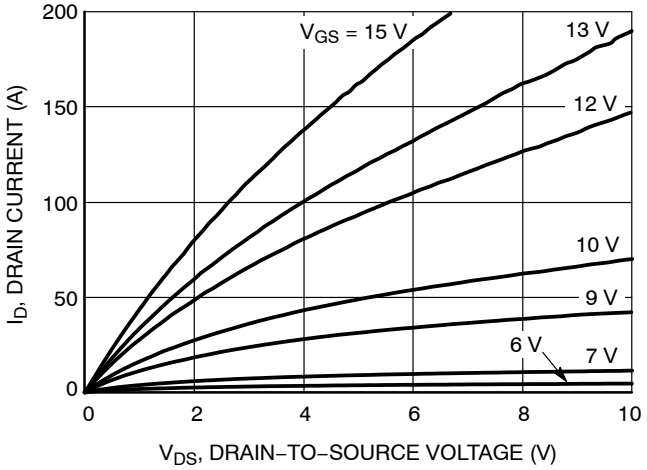


Figure 1. On−Region Characteristics

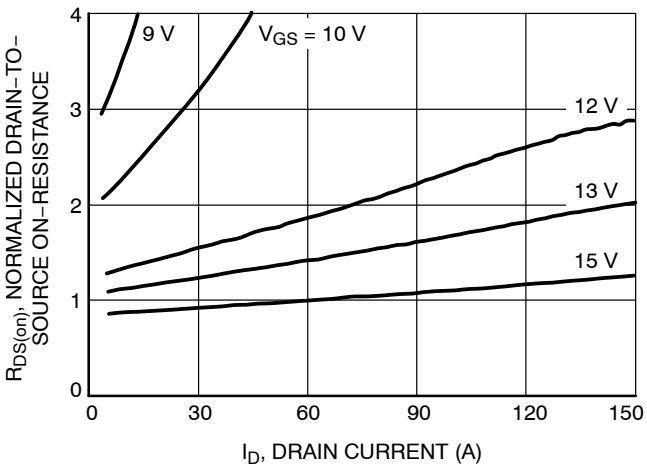


Figure 2. Normalized On−Resistance vs. Drain Current and Gate Voltage

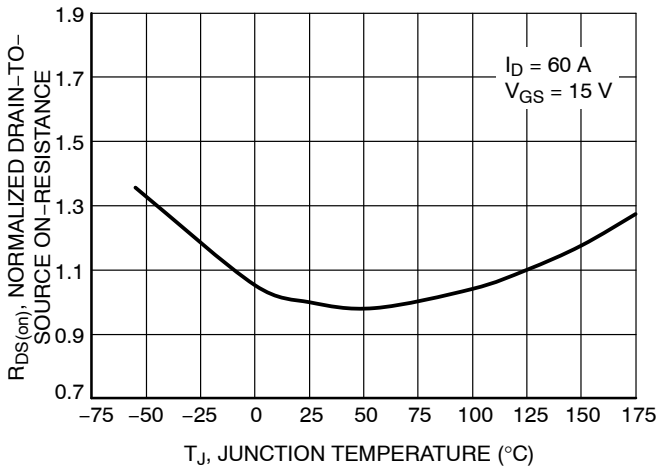


Figure 3. On−Resistance Variation with Temperature

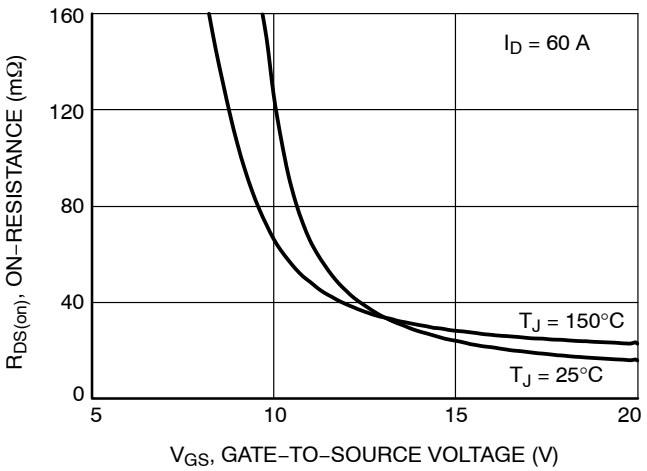


Figure 4. On−Resistance vs. Gate−to−Source Voltage

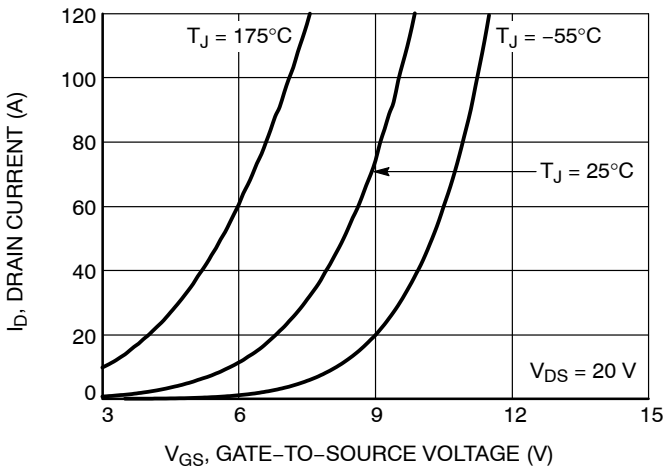


Figure 5. Transfer Characteristics

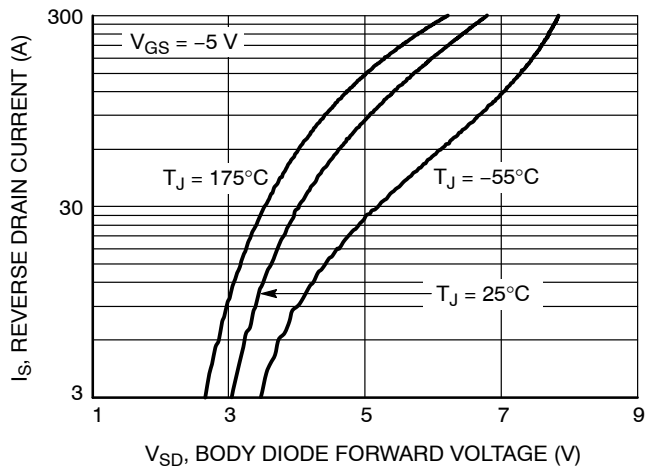


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS (continued)

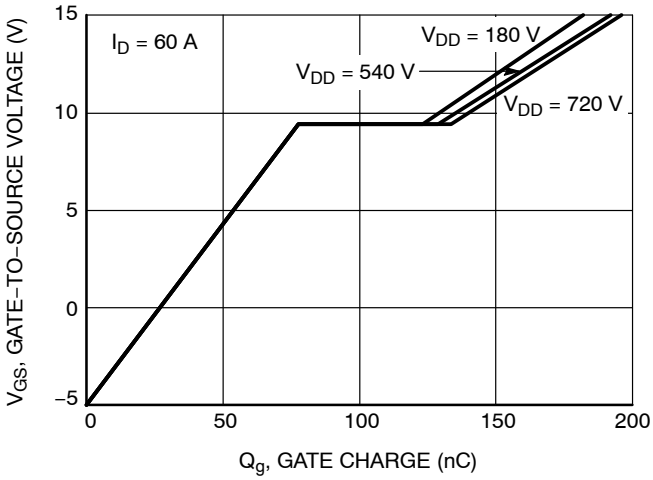


Figure 7. Gate−to−Source Voltage vs. Total Charge

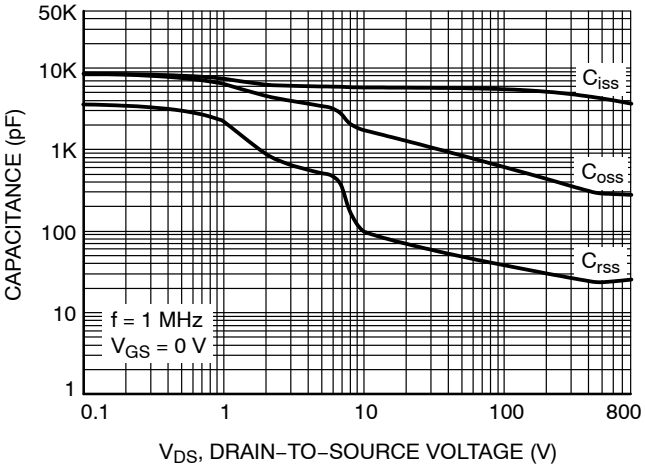


Figure 8. Capacitance vs. Drain−to−Source Voltage

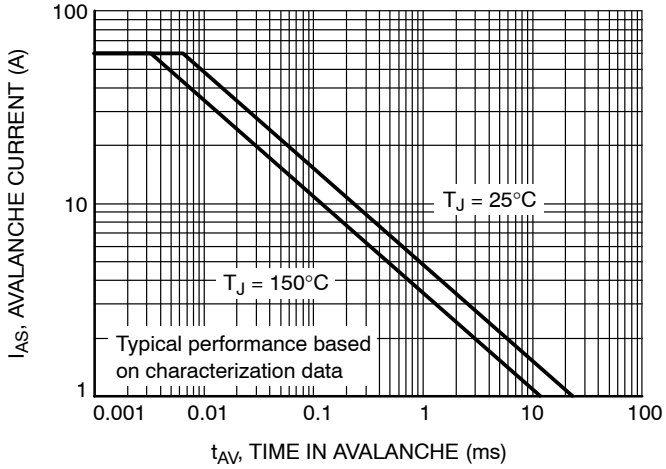


Figure 9. Unclamped Inductive Switching Capability

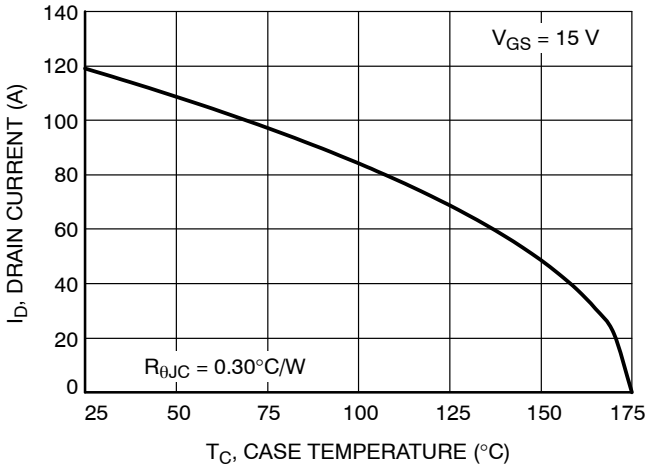


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

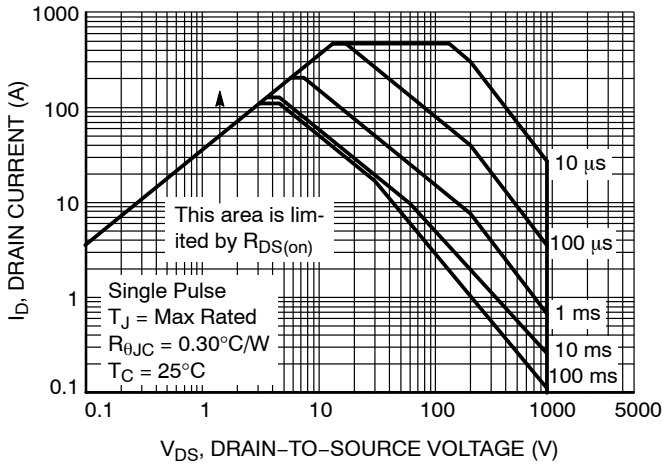


Figure 11. Safe Operating Area

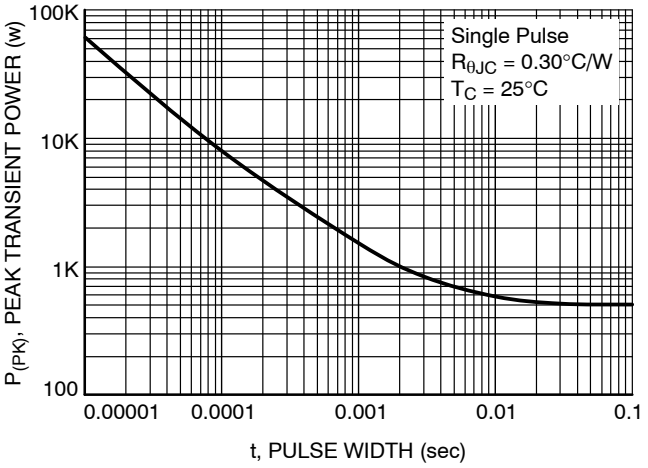


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (continued)

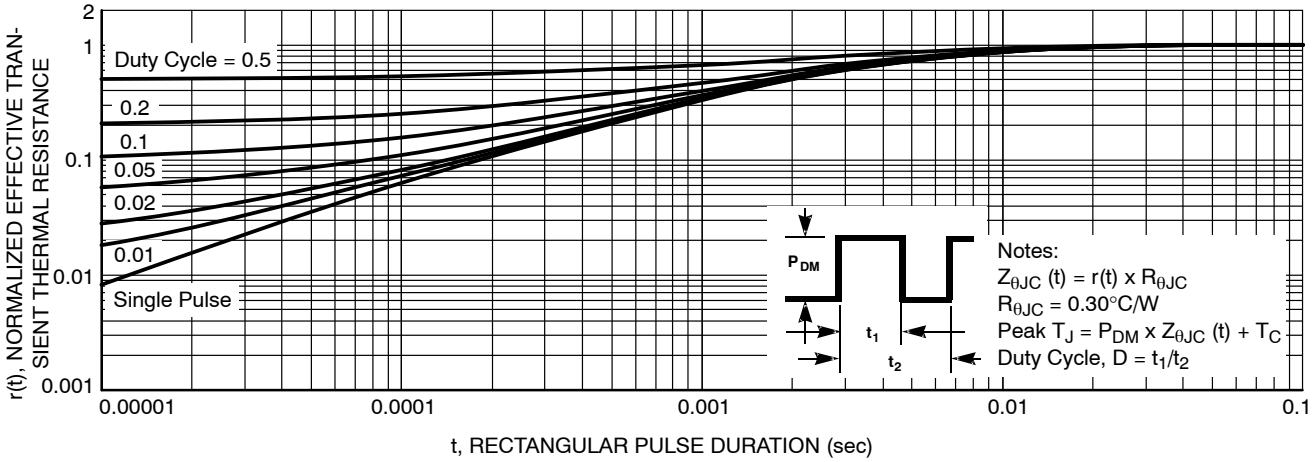
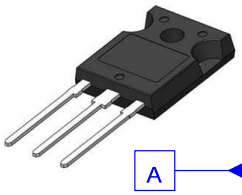
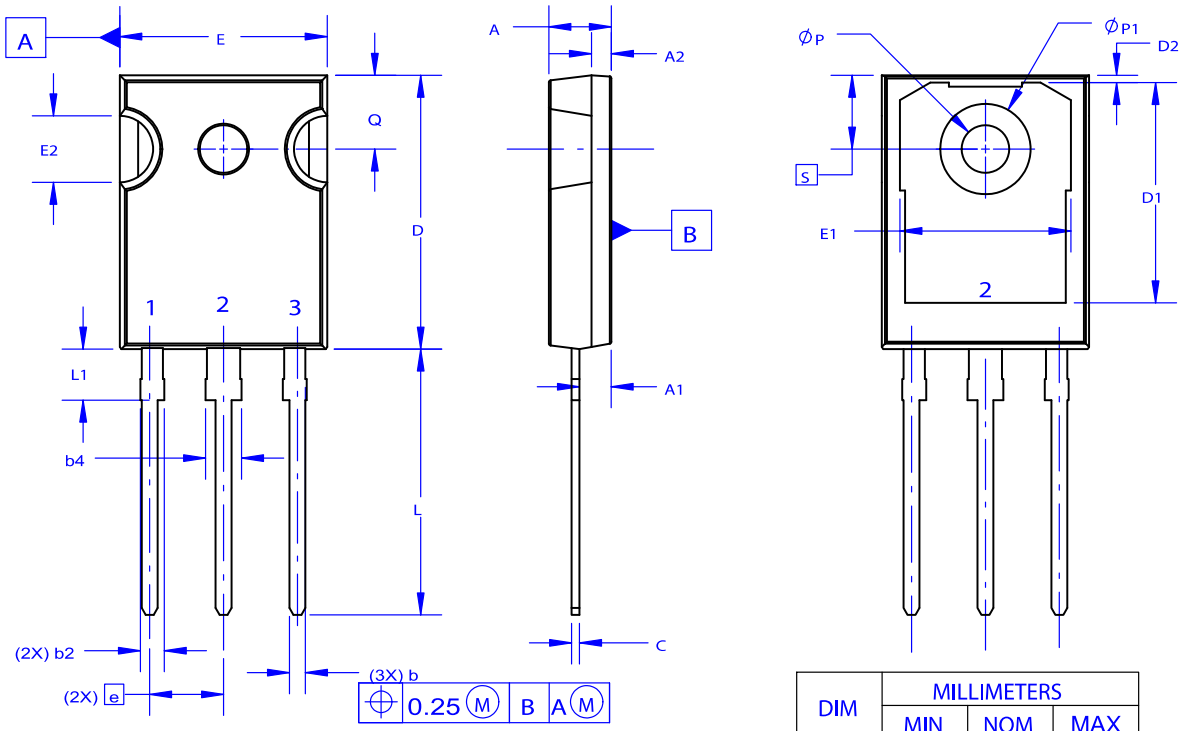


Figure 13. Junction−to−Ambient Transient Thermal Response Curve

TO−247−3LD
CASE 340CX
ISSUE A

DATE 06 JUL 2020





NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.60	6.80	7.00

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present. Some products may not follow the Generic Marking.

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